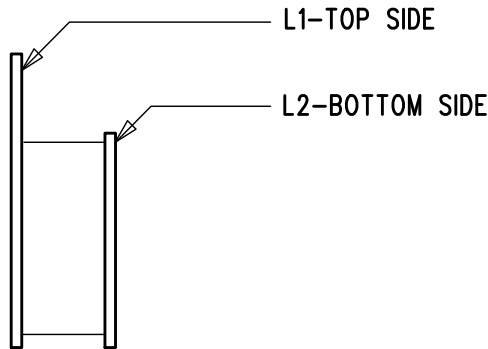


BOARD DIMENSION

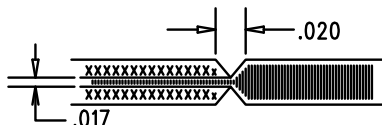
84mm x 62mm

LAYER STRUCTURE



NOTES: UNLESS OTHERWISE SPECIFIED

1. FAB PER IPC-A-600.
2. MATERIAL: -EPOXY FIBERGLASS, NEMA GRADE FR-4
-FINISHED THICKNESS TO BE 0.062" +/- .005"
-TOTAL OF 2 LAYERS WITH 2 OZ. CU ON THE OUTER LAYERS
AND 1 OZ. CU ON THE INNER LAYERS.
-FLAMMABILITY RATING: 94 V-0 MINIMUM.
3. SIZE: CUT TO DIMENSIONS AND TOLERANCES SHOWN.
0.00" ARE PRIMARY DATUMS.
4. DRILLING: -DRILL HOLES PER SCHEDULE. PLATE THROUGH
HOLES WITH COPPER, 0.001" THICK MIN.
-ALL HOLE SIZES ARE SPECIFIED AFTER PLATING.
-HOLE LOCATION TOLERANCES ARE +/-0.003"
IN RELATION TO CENTER
-FOR VIAS SIZE > 0.01", VIAS HOLES NEED TO BE PLUGGED
AND COVERED WITH SOLDERMASK.
5. FINISH: -SMOBC USING LPI BOTH SIDES, COLOR GREEN.
-GOLD IMMERSION BOTH SIDES.
(LEAD FREE SOLDER CAN BE USED FOR PROTOTYPE)
-FOR SILKSCREEN: BOTH SIDES USE WHITE NON-CONDUCTIVE INK.
6. DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE.
PAD SIZE CAN BE MODIFIED TO MEET END FINISH.
7. PCBs ARE TO BE RoHS COMPLIANT.
8. SCORING FOR PANELIZED PCB:



1630 MCCARTHY BLVD
MILPITAS, CA 95035
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TITLE: FABRICATION NOTES

IO-LINK TRANSCEIVER

SIZE	IC NO.	LT3669IUF	REV
N/A		DEMO CIRCUIT 2227A	1
FILENAME:			SHT 1 OF 1